

Polar3[™] HiperFET[™] **Power MOSFET**

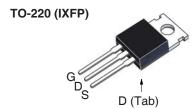
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier

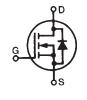
IXFA20N50P3 IXFP20N50P3 IXFQ20N50P3 IXFH20N50P3

500V 20A $300 \text{m}\Omega$

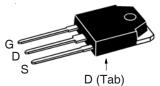
TO-263 (IXFA)







TO-3P (IXFQ)	
•	



= Drain

Symbol	Test Conditions	Maximum Ratir	ngs	TO-247 (IXFH)
V _{DSS}	$T_{_{\rm J}}$ = 25°C to 150°C	500	V	
V_{DGR}	$T_{_{\rm J}} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{_{\rm GS}} = 1\text{M}\Omega$	500	V	
V _{gss}	Continuous	± 30	V	
V _{GSM}	Transient	± 40	V	G
I _{D25}	$T_{c} = 25^{\circ}C$	20	Α	D S D (Tab)
I _{DM}	$T_{c} = 25^{\circ}C$, Pulse Width Limited by T_{JM}	40	Α	

300	mJ	S = Source	Tab = Drain	

V _{DSS}	$T_{J} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	500	V
V _{DGR}	$T_{_{\rm J}}$ = 25°C to 150°C, $R_{_{\rm GS}}$ = 1M Ω	500	V
V_{GSS}	Continuous	± 30	V
V _{GSM}	Transient	± 40	V
I _{D25}	$T_{c} = 25^{\circ}C$	20	Α
I _{DM}	$\rm T_{\rm C}$ = 25°C, Pulse Width Limited by $\rm T_{\rm JM}$	40	A
I _A	$T_{C} = 25^{\circ}C$	10	Α
E _{AS}	$T_{c} = 25^{\circ}C$	300	mJ
dv/dt	$I_{_{\mathrm{S}}} \le I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \le V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \le 150^{\circ}\mathrm{C}$	35	V/ns
P _D	T _c = 25°C	380	W
T _J		-55 +150	°C
\mathbf{T}_{JM}		150	°C
T _{stg}		-55 +150	°C
T_L	Maximum Lead Temperature for Soldering	300 260	°C °C
T _{SOLD}	Plastic Body for 10s		
F _c M _d	Mounting Force (TO-263) 10. Mounting Torque (TO-220, TO-3P & TO-247	65 / 2.214.6 () 1.13 / 10	N/lb Nm/lb.in
Weight	TO-263	2.5	g
	TO-220	3.0	g
	TO-3P TO-247	5.5 6.0	g g

Symbol Test Conditions (T _J = 25°C Unless Otherwise Specified)		Charac Min.	teristic Typ.	Values Max.	
BV _{DSS}	$V_{GS} = 0V, I_{D} = 1mA$	500			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 1.5 \text{mA}$	3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			25 1.25	•
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$			300	mΩ

Features

G = Gate

- Fast Intrinsic Rectifier
- Avalanche Rated
- $^{\bullet}$ Low $\rm R_{\rm \scriptscriptstyle DS(ON)}$ and $\rm Q_{\rm \scriptscriptstyle G}$
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls



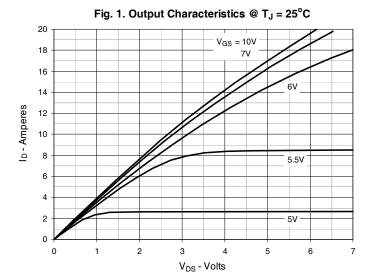
		racteristic Values		
$(1_{J} = 25^{\circ} \text{C})$	onless Otherwise Specified)	Min.	Тур.	Max.
g _{fs}	$V_{DS} = 20V$, $I_{D} = 0.5 \cdot I_{D25}$, Note 1	11	18	S
C _{iss}			1800	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		230	pF
C _{rss}			8.3	pF
R _{Gi}	Gate Input Resistance		2.3	Ω
t _{d(on)}	Resistive Switching Times		10	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		5	ns
t _{d(off)}	$R_{G} = 5\Omega$ (External)		43	ns
t _f	$n_{\rm G} = 352$ (External)		9	ns
$Q_{g(on)}$			36	nC
Q_{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		7	nC
Q_{gd}			13	nC
R _{thJC}				0.36 °C/W
R _{thCS}	TO-220		0.50	°C/W
	TO-247 & TO-3P		0.25	°C/W

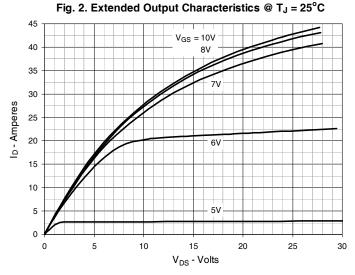
Source-Drain Diode

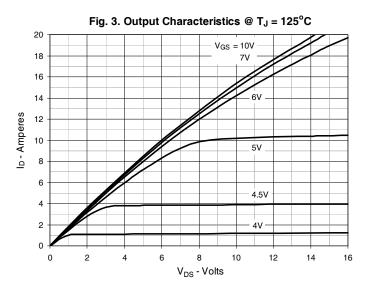
SymbolTest ConditionsCharacteristics $(T_J = 25^{\circ}\text{C Unless Otherwise Specified})$ Min.		 racteristic Typ.	Values Max.	
I _s	$V_{GS} = 0V$		20	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$		80	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1		1.4	V
t _{rr}	L = 10A =di/dt = 100A/us		250	ns
I _{RM}	$I_F = 10A$, -di/dt = 100A/ μ s $V_R = 100V$, $V_{GS} = 0V$	8.0		Α
Q_{RM}	$v_{R} = 100v, v_{GS} = 0v$	0.6		μC

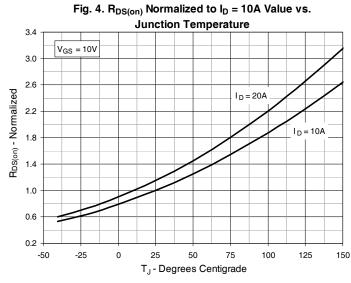
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

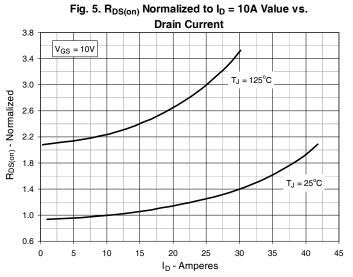


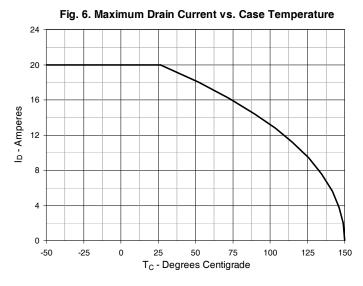




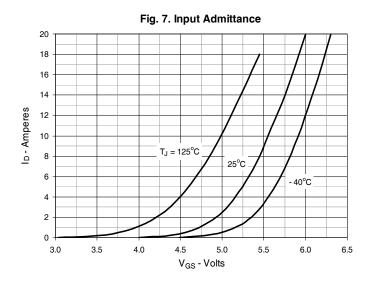


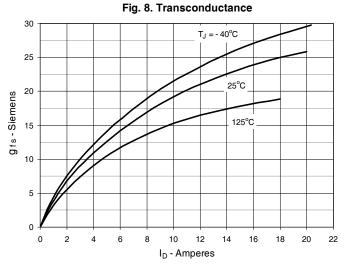


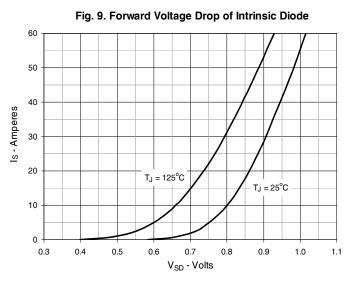


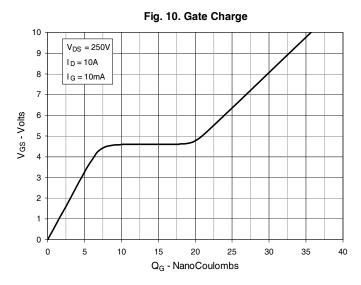


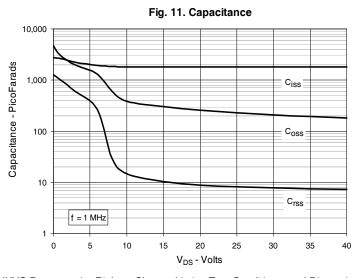


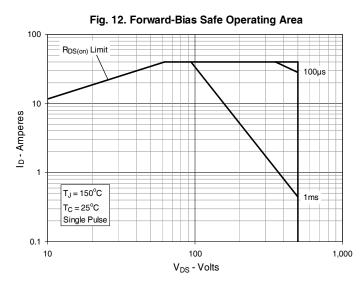












 $\ensuremath{\mathsf{IXYS}}$ Reserves the Right to Change Limits, Test Conditions, and Dimensions.



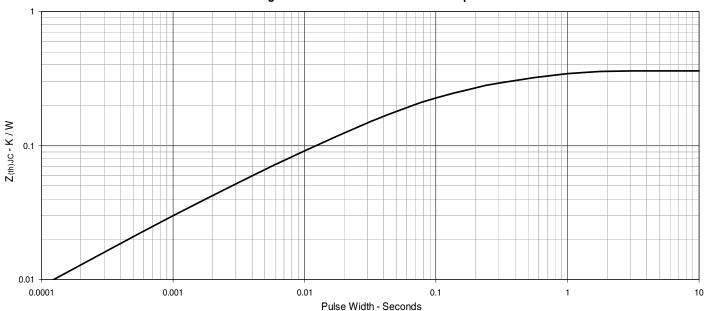
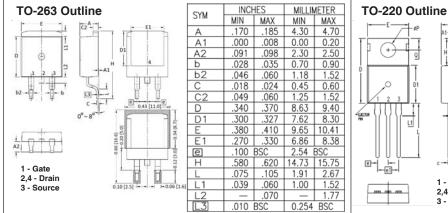
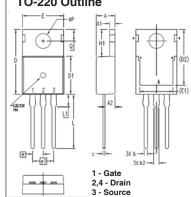


Fig. 13. Maximum Transient Thermal Impedance

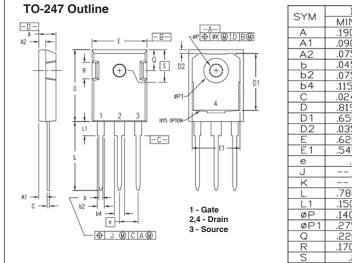


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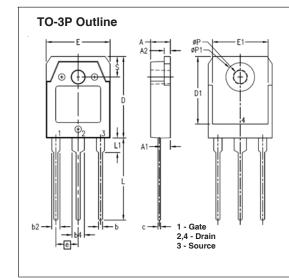




MYZ	INC	HES	MILLIM	ETERS
21M	MIN	MAX	MIN	MAX
Α	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
Ь	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
С	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
E	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
е	.100 BSC		2.54	BSC
e1	.200	BSC	5.08	BSC
H1	.244	.268	6.20	6.80
Ĺ	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØΡ	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20



SYM	INCH	IES	MILLIN	1ETERS
STIVI	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2.92	3.20
С	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
Е	.620	.635	15.75	16.13
E1	.545	.565	13.84	14.35
е	.215	.215 BSC		BSC
J		.010		0.25
K		.025		0.64
L	.780	.810	19.81	20.57
L1	.150	.170	3.81	4.32
ØΡ	.140	.144	3.55	3.65
øP1	.275	.290	6.99	7.37
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.242	BSC	6.15 BSC	
,			0.10	200



SYM INCHES		IES	MILLIN	METERS
SIM	MIN	MAX	MIN	MAX
Α	.181	.197	4.60	5.00
Α1	.087	1.02	2.20	2.60
A2	.057	.065	1.45	1.65
σ	.031	.047	0.80	1.20
b2	.071	.087	1.80	2.20
b4	.110	.126	2.80	3.20
O	.022	.031	0.55	0.80
D	.776	.791	19.70	20.10
D1	.640	.680	16.26	17.27
Ε	.606	.622	15.40	15.80
E1	.531	.539	13,50	13.70
е	.215 BSC		5,45	BSC
Γ	.779	.795	19.80	20.20
L1	.130	.146	3.30	3.70
ØΡ	.122	.134	3.10	3,40
øP1	.272	.280	6.90	7.10
S	.189	.205	4.80	5.20

